## **Tyrone Camarero Specifications**

## Camarero DSA7TOAN-46R

## Key features

High Performance Computing, AI/Deep Learning Training 4U Dual Processor (3rd Gen Intel® Xeon®) GPU System with NVIDIA HGX A100 8-GPU 40GB/80GB, NVLink, NVSwitch.

- Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors
- Intel<sup>®</sup> C621A Chipset
- 32 DIMM Slots;Up to 8TB DRAM; Up to 8TB Intel<sup>®</sup> Optane<sup>™</sup> Persistent Memory (up to 12TB with DRAM); 3200/2933/2666 ECC DDR4 LRDIMM;RDIMM; Intel<sup>®</sup> Optane<sup>™</sup> Persistent Memory 200 series
- 10 PCI-E Gen 4.0 X16 LP Slots, AIOM/OCP 3.0 Support
- Flexible networking options

Processor/Cache

Processor

Chipset

Chipset

System Memory

Memory Capacity

**Expansion Slots** 

Integrated Onboard

Add-on Options

Network Connectivity 2x 10G

**PCI-Express** 

SATA

Raid Card

**Optical Drive** 

- 2 M.2 NVMe and SATA, 6x 2.5" Hot-swap NVMe/SATA/SAS drive bays
- 4 heavy duty fans with optimal fan speed control

4x 2200W redundant Titaniu redundant Titanium level po

t Titanium level power supplies / 4x 3000W level power supplies		XEON.
e	Drive Bays	
Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors	HDD Bays	6x 2.5" hot-swap NVMe/SATA/SAS drive bays (6x 2.5" NVMe hybrid; 4x 2.5" NVMe dedicated), 2 M.2 NVMe OR 2 M.2 SATA3
Intel® C621A Chipset	Power Supply	
,		
32 DIMM Slots;Up to 8TB DRAM; Up to 8TB Intel <sup>®</sup> Optane <sup>™</sup> Persistent Memory (up to 12TB with DRAM); 3200/2933/2666 ECC DDR4 LRDIMM; RDIMM;	4x 2200W redundant Titanium level power supplies / 4x 3000W redundant Titanium level power supplies <b>Cooling System</b>	
Intel <sup>®</sup> Optane <sup>™</sup> Persistent Memory 200 series		
10 PCI-E Gen 4.0 X16 LP Slots, AIOM/OCP 3.0 Support	4 heavy duty fans with optimal fan speed control	
board	Form Factor	
SATA3 (6Gbps); RAID 0/1/5/10 support ity 2x 10GbE BaseT with Intel® X550-AT2 (optional)		4U Rackmount Height : 6.9"" (174mm), Width : 17.6"" (446mm), Depth : 35.4"" (900mm)
Optional None	Email : info@tyronesystems.com For more/current product information, visit www.tyronesystems.com	

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None www.tyronesystems.com

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